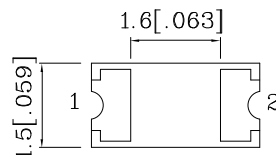
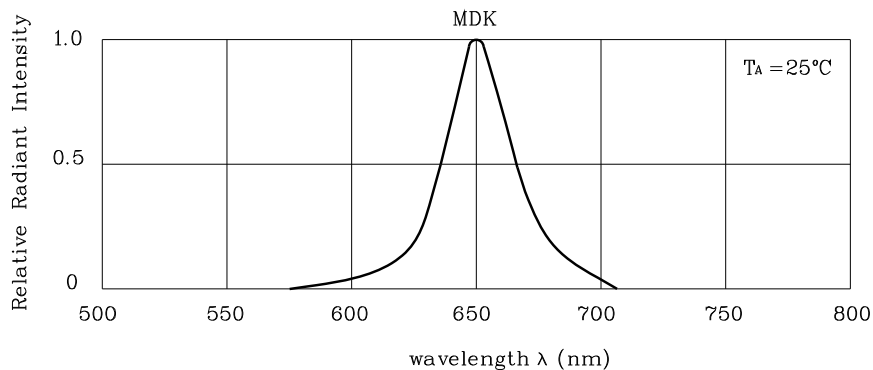


A circuit diagram showing a NOT gate (inverter) with input 1 and output 2.



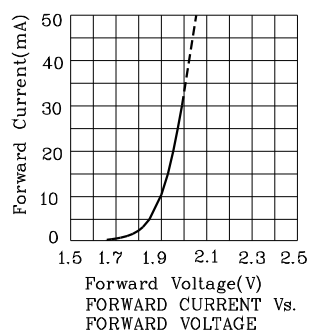
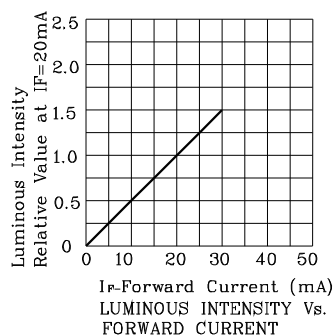
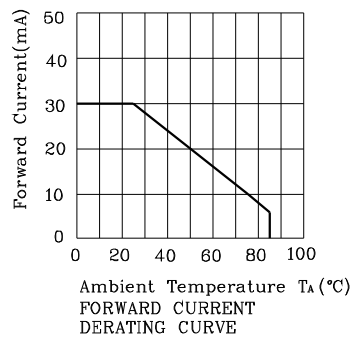
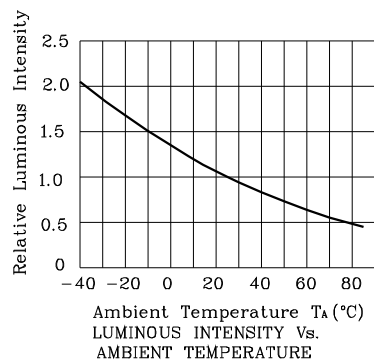
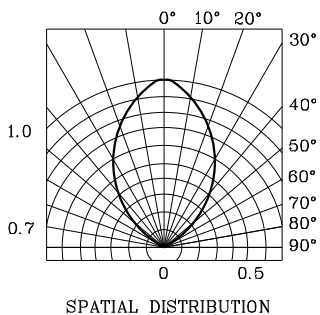
Operating Characteristics (TA=25°C)		MDK (InGaAlP)	Unit
Forward Voltage (Typ.) (IF=20mA)	VF	1.95	V
Forward Voltage (Max.) (IF=20mA)	VF	2.5	V
Reverse Current (Max.) (VR=5V)	IR	10	uA
Wavelength of Peak Emis- sion (Typ.) (IF=20mA)	λ p	650	nm
Wavelength of Dominant Emission (Typ.) (IF=20mA)	λ D	635	nm
Spectral Line Full Width At Half-Maximum (Typ.) (IF=20mA)	$\Delta\lambda$	28	nm
Capacitance (Typ.) (VF=0V, f=1MHz)	C	35	pF

Part Number	Emitting Color	Emitting Material	Lens-color	Luminous Intensity (IF=20mA) mcd	Wavelength nm λ P	Viewing Angle 2 θ 1/2
				min.	typ.	
ZMDK60W	Red	InGaAlP	Water Clear	70	238	650
Published Date : FEB 23, 2008		Drawing No : SDSA2523		V5	Checked : B.L.LIU	P.1/4

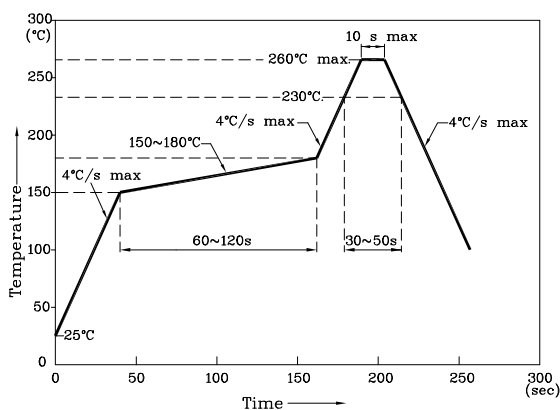


RELATIVE INTENSITY Vs. WAVELENGTH

❖ MDK



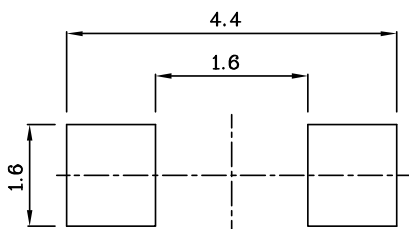
Reflow Soldering Profile For Lead-free SMT Process.



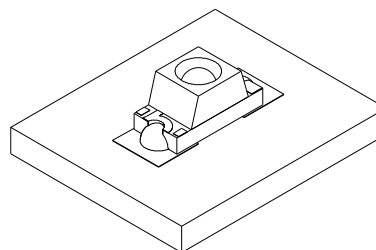
NOTES:

1. Maximum soldering temperature should not exceed 260°C.
2. Recommended reflow temperature: 145°C–260°C.
3. Do not put stress to the epoxy resin during high temperatures conditions.

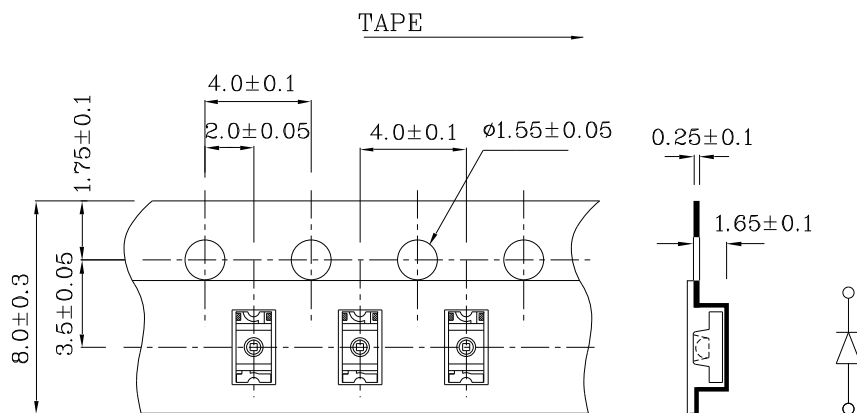
❖ Recommended Soldering Pattern
(Units : mm; Tolerance: ± 0.1)



❖ The device has a single mounting surface. The device must be mounted according to the specifications.



❖ Tape Specification (Units : mm)



Remarks:

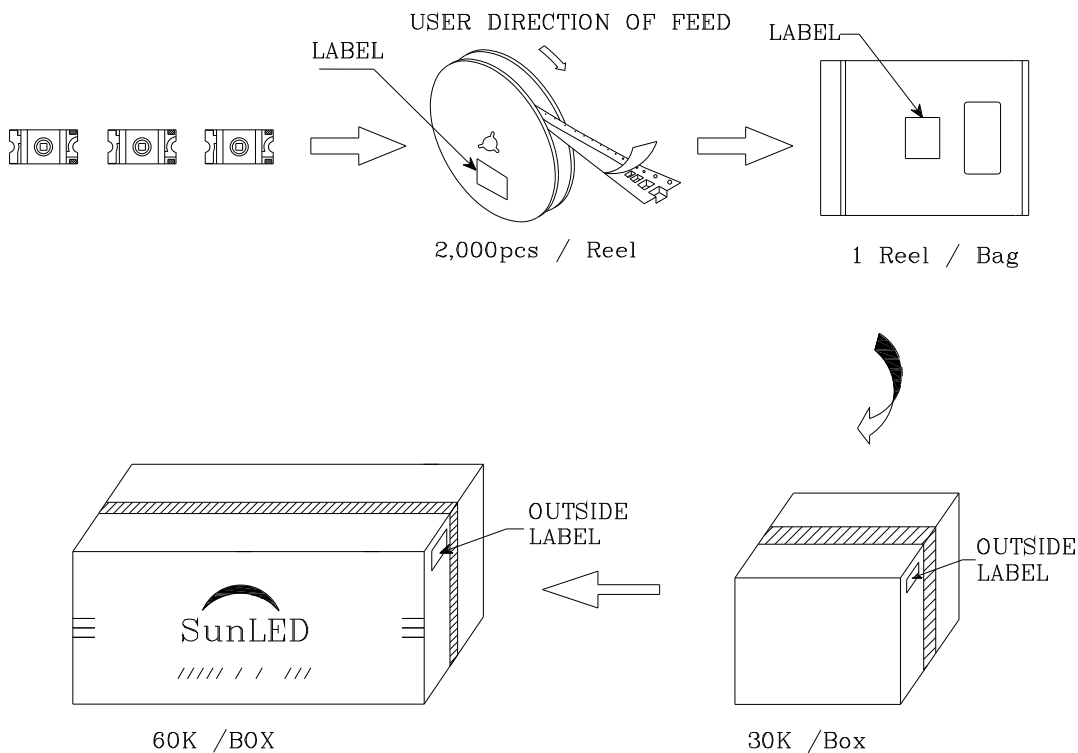
If special sorting is required (e.g. binning based on forward voltage, Luminous intensity / luminous flux, or wavelength), the typical accuracy of the sorting process is as follows:

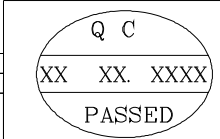
1. Wavelength: $\pm 1\text{nm}$
2. Luminous intensity / luminous flux: $\pm 15\%$
3. Forward Voltage: $\pm 0.1\text{V}$

Note: Accuracy may depend on the sorting parameters.

PACKING & LABEL SPECIFICATIONS

ZMDK60W



 	
P/NO : Zxx60x	
QTY : 2,000 pcs	CODE: XXX
S/N : XX	
LOT NO:  XXXXXXXXXXXXXXXXXXXX	
RoHS Compliant	